5 D



NCE N-Channel Super Trench II Power MOSFET

Description

The NCEP040N85G uses Super Trench II technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS}(\text{ON})}$ and $Q_{\text{g}}.$ This device is ideal for high-frequency switching and synchronous rectification.

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

General Features

- V_{DS} =85V,I_D =130A $R_{DS(ON)}$ =3.5m Ω (typical) @ V_{GS} =10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating

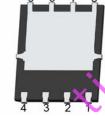
100% UIS TESTED! 100% ΔVds TESTED!

Schematic Diagram

DFN 5X6



Top View



Bottom View



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP040N85G	NCEP040N85G	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

✓ Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	85	V
Gate-Source Voltage	V _G S	±20	V
Drain Current-Continuous	I _D	130	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	93.6	А
Pulsed Drain Current	I _{DM}	520	А
Maximum Power Dissipation	P _D	150	W
Derating factor		1.2	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	870	mJ
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}$

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	$R_{ heta JC}$	0.83	°C/W

Electrical Characteristics (T_C=25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	85		-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =85V,V _{GS} =0V	-	-	1	μΑ	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA	
On Characteristics (Note 3)							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2	3	4	V	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =65A	-	3.5	4.0	mΩ	
Forward Transconductance	9 FS	V _{DS} =5V,I _D =65A		60	-	S	
Dynamic Characteristics (Note4)			1				
Input Capacitance	C _{lss}	\/ 40\/\/ 0\/	-7	4950	-	PF	
Output Capacitance	Coss	V _{DS} =40V,V _{GS} =0V, F=1.0MHz	-	850	-	PF	
Reverse Transfer Capacitance	C _{rss}	F=1.UIVID2	-	40	-	PF	
Switching Characteristics (Note 4)	Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}	15	-	18	-	nS	
Turn-on Rise Time	t _r	V_{DD} =40 V , I_{D} =65 A	-	11	-	nS	
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =3 Ω	-	38	-	nS	
Turn-Off Fall Time	t _f	0.7	-	9	-	nS	
Total Gate Charge	Qg	V _{DS} =40V,I _D =65A,	-	88	-	nC	
Gate-Source Charge	Qgs	$V_{DS}=40V,I_{D}=65A,$ $V_{GS}=10V$	-	22		nC	
Gate-Drain Charge	Q _{gd}	V _{GS} -10V	-	25		nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =65A	-		1.2	V	
Diode Forward Current (Note 2)	Is		-	-	130	Α	
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F =65A	-	72	-	nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	102	-	nC	

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\text{C}$,V $_{\text{DD}}$ =40V ,V $_{\text{G}}$ =10V ,L=0.5mH ,Rg=25 Ω





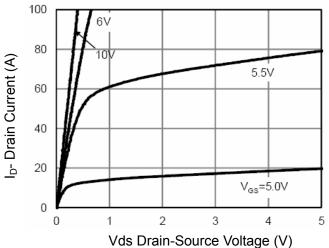


Figure 1 Output Characteristics

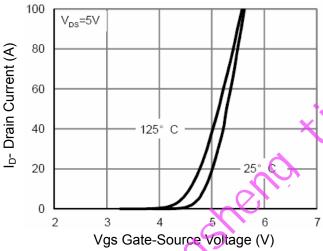


Figure 2 Transfer Characteristics

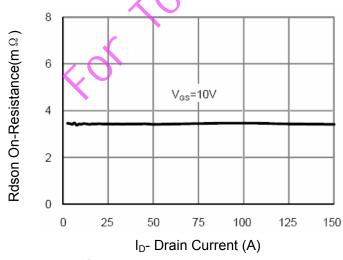


Figure 3 Rdson- Drain Current

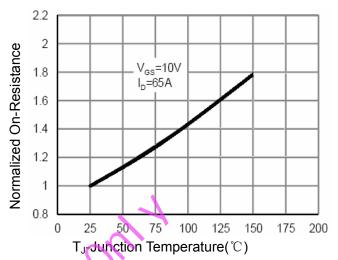


Figure 4 Rdson-Junction Temperature

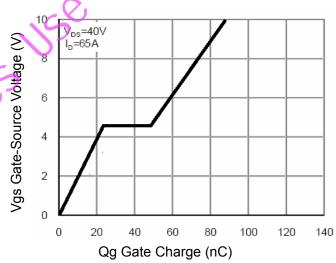


Figure 5 Gate Charge

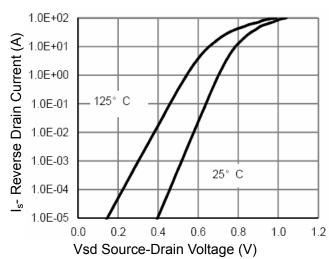


Figure 6 Source- Drain Diode Forward



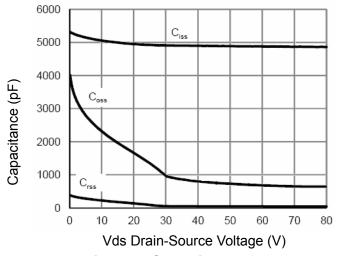


Figure 7 Capacitance vs Vds

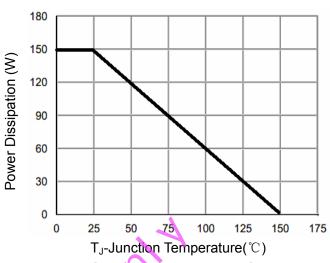


Figure 9 Power De-rating

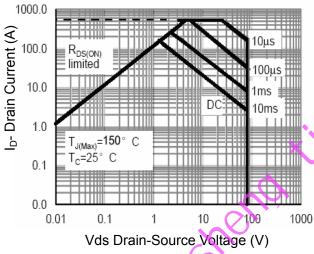


Figure 8 Safe Operation Area

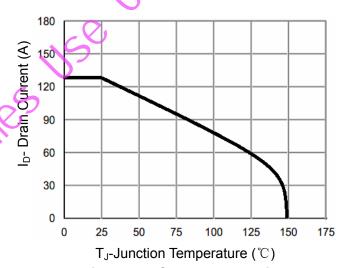


Figure 10 Current De-rating

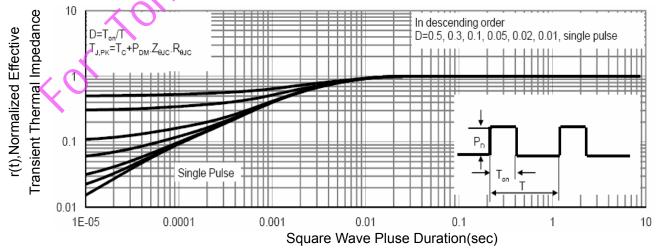
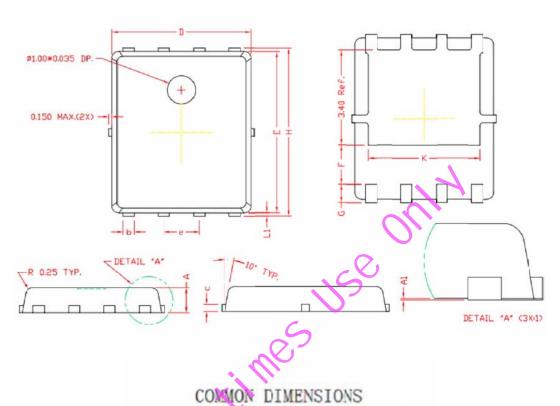


Figure 11 Normalized Maximum Transient Thermal Impedance



DFN5X6-8L Package Information



COMMON DIMENSIONS

(UNITS OF MEASURE=MILLIMETER)

	SYMBOL	MIN	NOM	MAX	
	A	0.80	0.90	1.00	
	C A1	0.00	0.03	0.05	
	Ь	0.35	0.42	0.49	
	c	0. 254 REF.			
	D	4.90	5.00	5. 10	
	F	1			
	E	5. 70	5. 80	5. 90	
~ O	е	1.27 BSC.			
	Н	5. 95	6.08	6. 20	
	L1	0.10	0.14	0.18	
	G	0.60 REF.			
	K	4			



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